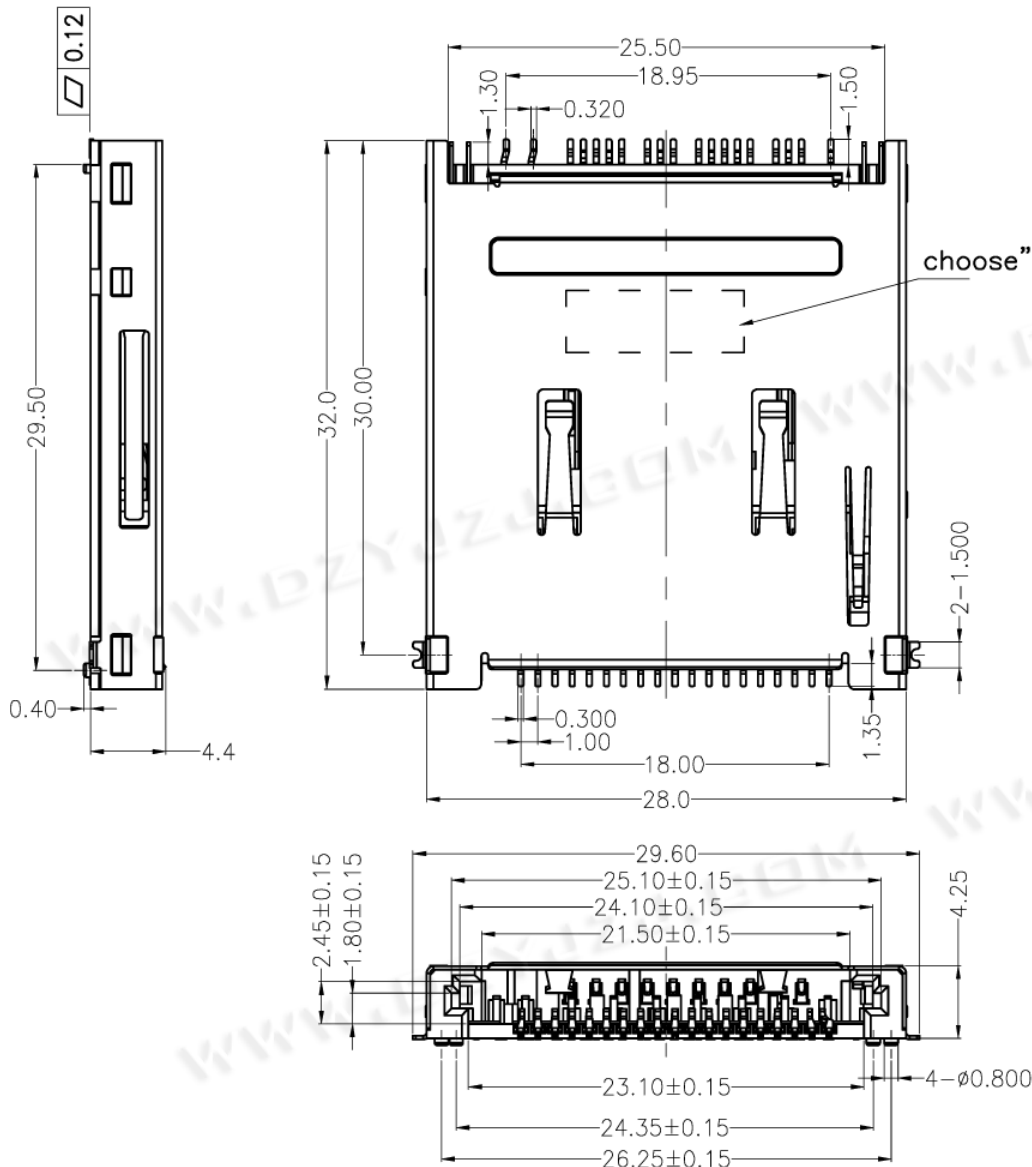




Specification

MATERIAL:

Insulator: High Temperature Thermoplastic,
UL 94V-0.

Contact: Copper Alloy

Shell: Copper Alloy

PLATING:

Contact: Plated 50u" Ni Overall

Plated Au Selective Contact Area

Plated 100u" Sn Over Ni On Solder Area

Shell: Plated 50u" Ni Overall

Plated 1u"Au Selective Contact Area

Electrical:

Current Rating :0.5A AC/DC max.

Voltage Rating :125V AC/DC

Ambient Temperature Range : $-20^{\circ}\text{C}\sim+60^{\circ}\text{C}$

Ambient Humidity Range :95% R.H. Max.

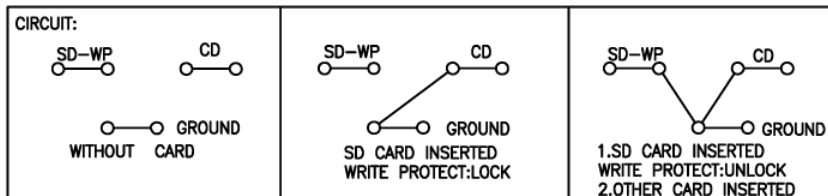
Contact Resistance:100m Ω max.

Insulation Resistance:1000M Ω min./500VDC

Durability:10,000 cycles

Usable Memory Card:

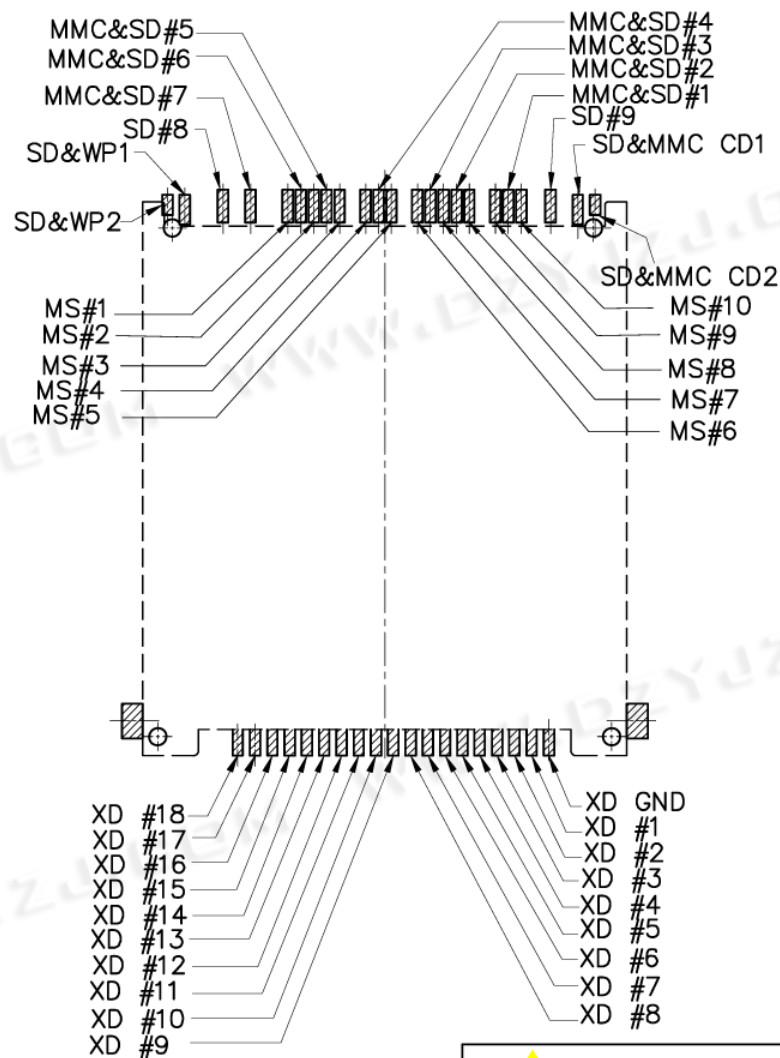
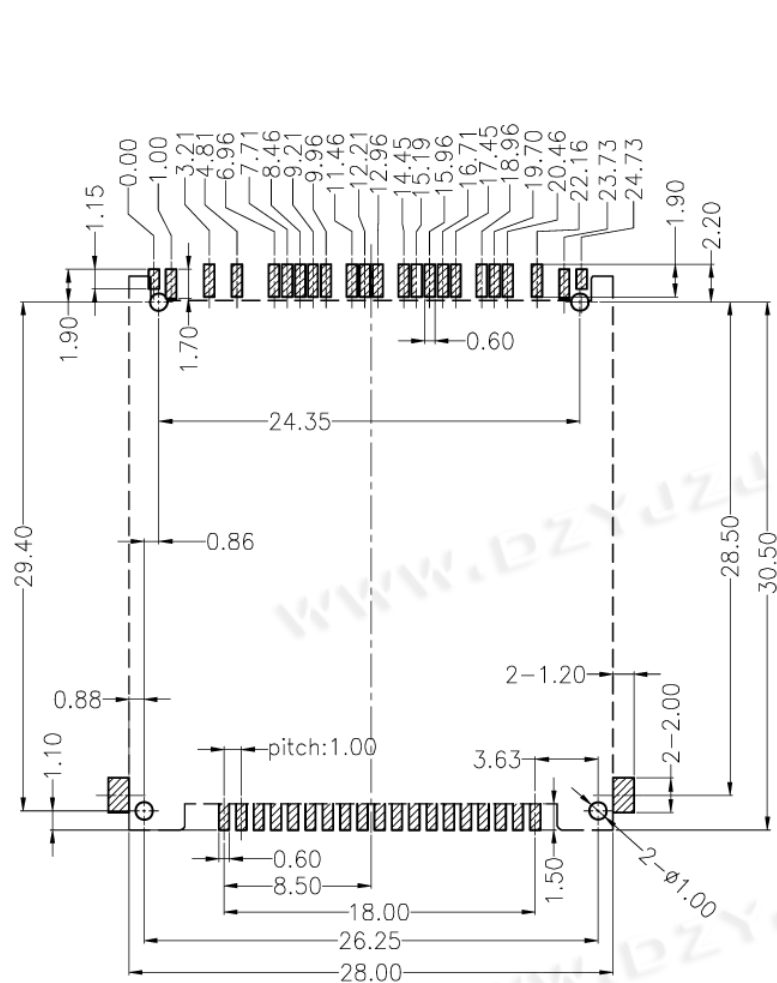
SD&MMC&MS&XD Card



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TOLERANCE: X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X' $\pm 2^{\circ}$ X.X' $\pm 0.5^{\circ}$	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 四合一TS卡座
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC08-4IN142-280
	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HYC-IN125320120
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1

RECOMMEND PCB LAYOUT:

(Unit:mm .X ± 0.15 .XX ± 0.05 .XXX ± 0.02)

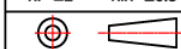
PIN ASSIGNMENT:

PIN NO.	MEMORY CARD PIN NO.
MMC&SD#1	MMC/SD-1 (CD/DAT3)
MMC&SD#2	MMC/SD-2 (CMD)
MMC&SD#3	MMC/SD-3 (Vss1)
MMC&SD#4	MMC/SD-4 (VDD)
MMC&SD#5	MMC/SD-5 (CLK)
MMC&SD#6	MMC/SD-6 (Vss2)
MMC&SD#7	MMC/SD-7 (DAT0)
SD#8	SD-8 (DAT1)
SD#9	SD-9 (DAT2)
XD#1	CD
XD#2	R/-B
XD#3	-RE
XD#4	-CE
XD#5	CLE
XD#6	ALE
XD#7	-WE
XD#8	-WP
XD#9	GND
XD#10	D0
XD#11	D1
XD#12	D2
XD#13	D3
XD#14	D4
XD#15	D5
XD#16	D6
XD#17	D7
XD#18	VCC
MS#1	VSS
MS#2	BS
MS#3	DATA1
MS#4	SDIO/DATA0
MS#5	DATA2
MS#6	INS
MS#7	DATA3
MS#8	SCLK
MS#9	VCC
MS#10	VSS



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TOLERANCE:

X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X' $\pm 2'$ X.X' $\pm 0.5'$ 

UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

四合一TS卡座

CHECKED BY:

马跃

DATE :

2014-02-23

APPROVED BY:

邱国夷

DATE :

2014-02-23

PART NO.

HYC08-4IN142-280

MOLD NO.

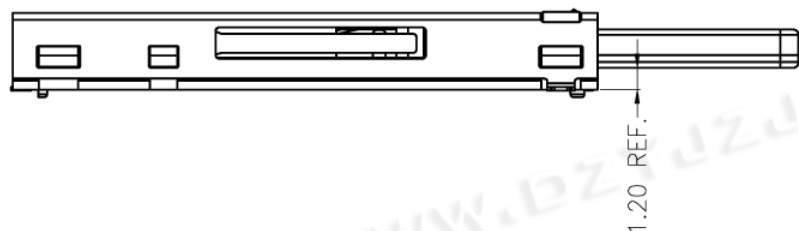
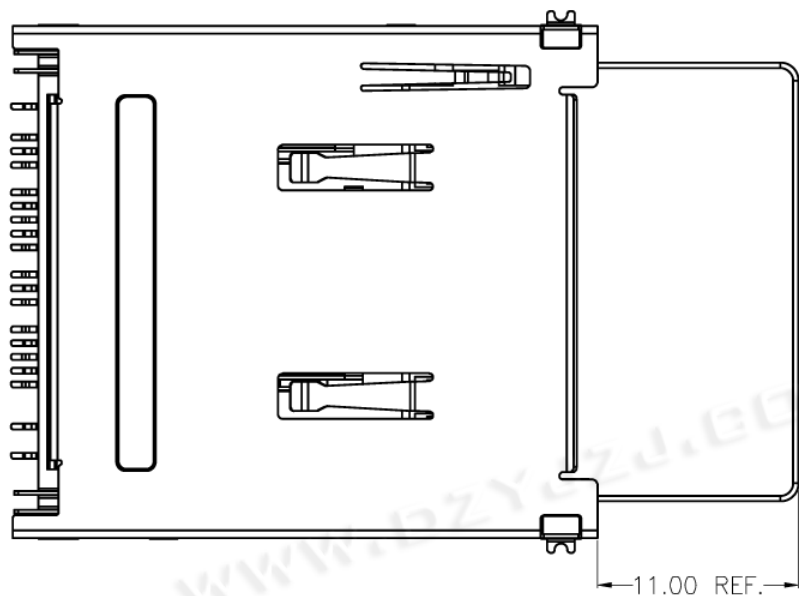
DRAW NO:

HYC-IN125320120

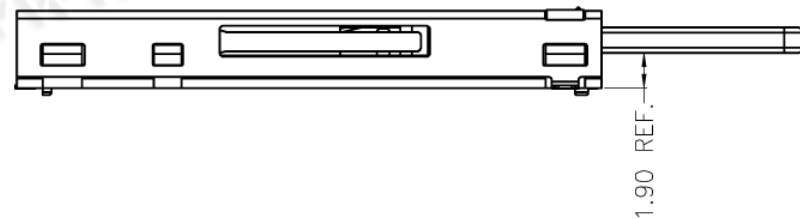
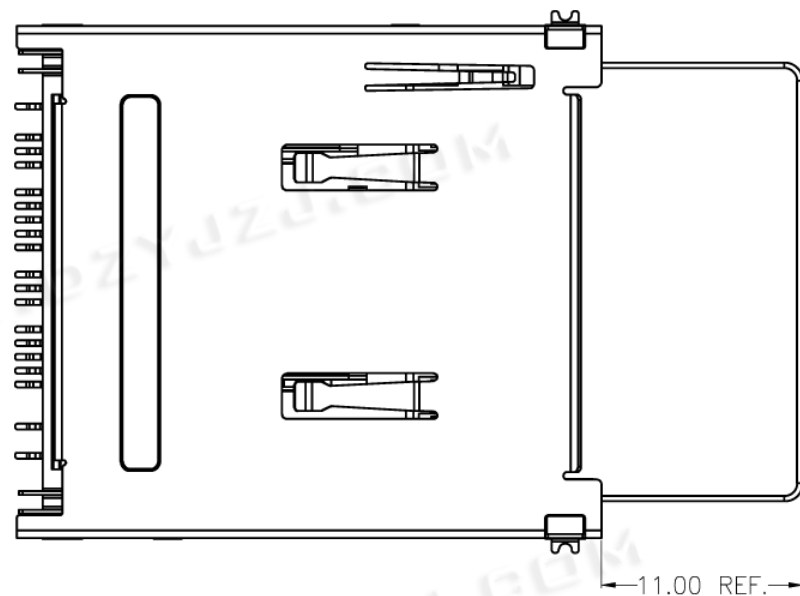
SHEET NO.

2 OF 5

SD Card Insert Drawing:



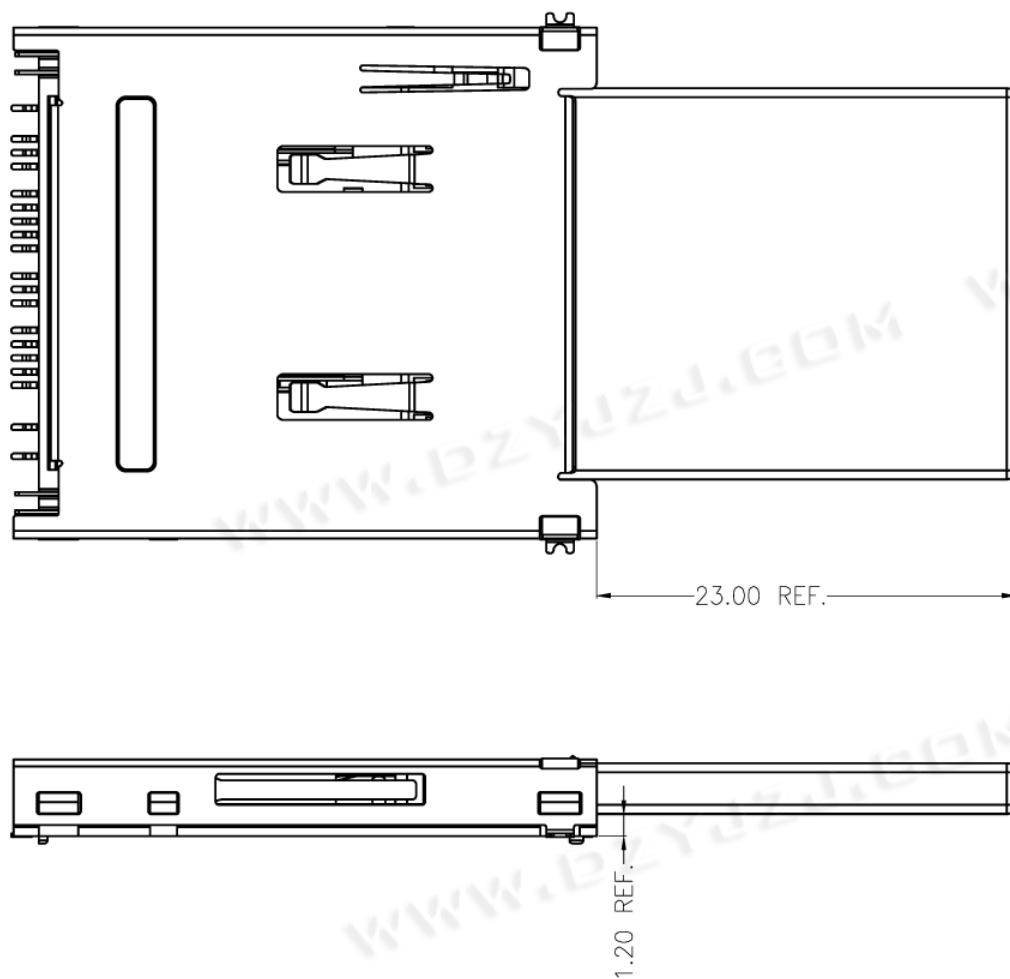
MMC Card Insert Drawing:



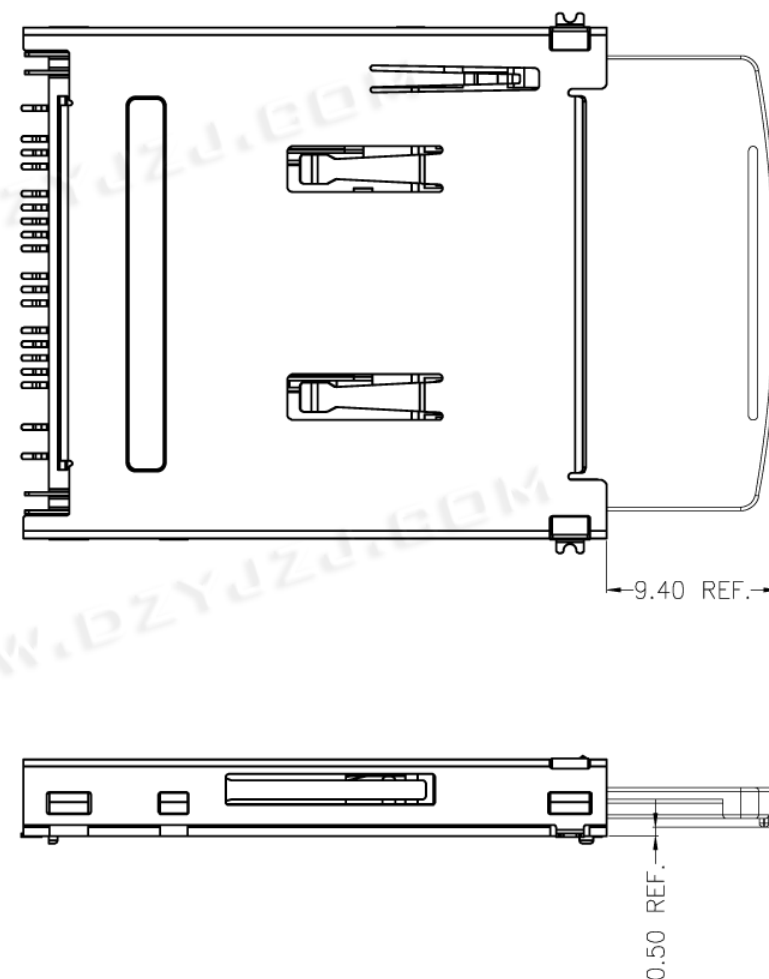
深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2° X.* ±0.5°	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 四合一TS卡座	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC08-4IN142-280
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO:	HYC-IN125320120
			SHEET NO.	3 OF 5

MS Card Insert Drawing:



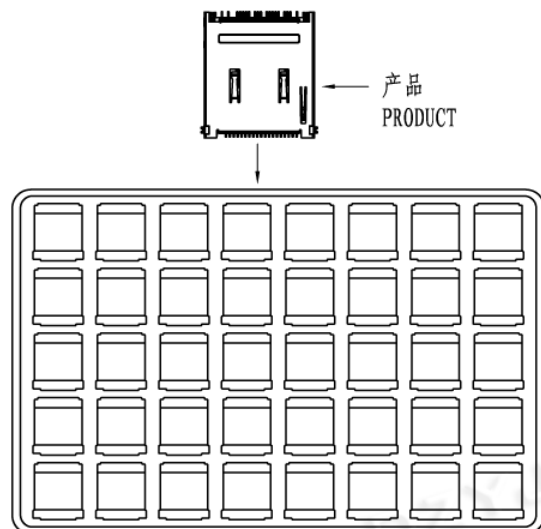
XD Card Insert Drawing:



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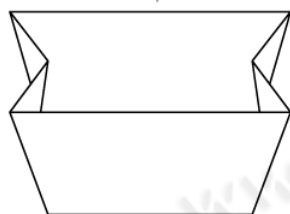
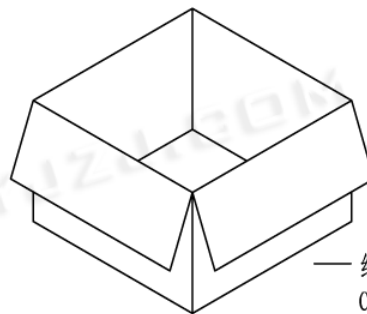
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X." ±2" X.X" ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 四合一TS卡座	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC08-4IN142-280
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-IN125320120
			SHEET NO.	4 OF 5

THE PACKING FOR SD CARD SERIES PUSH TYPE

产品
PRODUCT

真空盘(规格): 325*210*12mm

TRAY SPEC.: 325*210*12mm

真空盘
TRAY防水袋
WATER PROOF BAG

纸箱(规格): 350(L)*240(W)*280(H)mm

CARTON SPEC.: 350(L)*240(W)*280(H)mm

注意 (Note):

1. 将产品一一放入真空盒内, 依同一方向摆放
PUT PRODUCT INTO THE TRAY, AND AS SAME DIRECTION
2. 产品放置时, 如图所示
THE DIRECTION REFERS TO DRAWING
3. 每个真空盘装入40pcs 产品
QUANTITY OF PER TRAY: 40 PCS
4. 一个纸箱可放入40个真空盘
QUANTITY OF PER CARTON: 40 TRAYS
5. 最上面一个真空盘用作上盖, 不装入产品
THE TOP TRAY NOT PUT INTO PRODUCT
AS A COVER TO PROTECT PRODUCT
5. 一个纸箱可装入1500 PCS产品
QUANTITY OF PER CARTON: 1500 PCS
6. 若有未装满之尾数箱, 必须用缓冲材加满
7. 装满产品之纸箱, 最大堆积数量为5箱
THE CARTON FULLY FILLED WITH PRODUCTS
THE MAX. ACCUMULATING QUANTITY IS 5 CARTONS
8. 产品单重为: 3.9g; 每箱单重为: 7.8kg/箱
THE WEIGHT OF PER PRODUCT: 3.9g; PER CARTON: 7.8Kg

PACKING STEP



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
UNIT: mm [inch]			SHEET NO.	1 OF 1
SCALE: 1:1	SIZE: A4			